Vishay Siliconix

P-Channel 20 V (D-S) MOSFET



Marking Code: P6

| PRODUCT SUMMARY | | | | | | |
|---|--------|--|--|--|--|--|
| V _{DS} (V) | -20 | | | | | |
| $R_{DS(on)}$ max. (Ω) at $V_{GS} = -4.5 \text{ V}$ | 0.061 | | | | | |
| $R_{DS(on)}$ max. (Ω) at $V_{GS} = -2.5 \text{ V}$ | 0.080 | | | | | |
| $R_{DS(on)}$ max. (Ω) at $V_{GS} = -1.8 \text{ V}$ | 0.110 | | | | | |
| $R_{DS(on)}$ max. (Ω) at $V_{GS} = -1.5 \text{ V}$ | 0.165 | | | | | |
| Q _g typ. (nC) | 7.6 | | | | | |
| I _D (A) ^a | -4.4 | | | | | |
| Configuration | Single | | | | | |

FEATURES

- TrenchFET® power MOSFET
- 100% R_g tested
- Typical ESD performance 2000 V
- Built in ESD protection with Zener Diode
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

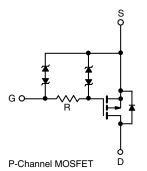


RoHS COMPLIANT

HALOGEN FREE

APPLICATIONS

 Load switch for portable devices



| ORDERING INFORMATION | | | | |
|---------------------------------|------------------|--|--|--|
| Package | SOT-23 | | | |
| Lead (Pb)-free and halogen-free | Si2377EDS-T1-GE3 | | | |

| PARAMETER | SYMBOL | LIMIT | UNIT | |
|--|------------------------|-----------------------------------|----------------------|-----|
| Drain-source voltage | | V _{DS} | -20 | v |
| Gate-source voltage | V _{GS} | ± 8 | | |
| Continuous drain current (T _J = 150 °C) | T _C = 25 °C | | -4.4 | |
| | T _C = 70 °C | | 3.5 | |
| | T _A = 25 °C | I _D | -3.7 b, c | |
| | T _A = 70 °C | | -2.9 b, c | A |
| Pulsed drain current | | I _{DM} | -20 | |
| Continuous source-drain diode current | T _C = 25 °C | | -1.5 | |
| | T _A = 25 °C | I _S | -1 b, c | |
| Maximum power dissipation | T _C = 25 °C | | 1.8 | |
| | T _C = 70 °C | | 1.1 | 14/ |
| | T _A = 25 °C | P _D | 1.25 ^{b, c} | W |
| | T _A = 70 °C | | 0.8 b, c | 7 |
| Operating junction and storage temperature range | | T _J , T _{stg} | -55 to +150 | °C |
| Soldering recommendations (peak temperature | | 260 | | |

| THERMAL RESISTANCE RATINGS | | | | | | |
|----------------------------------|--------------|-------------------|---------|---------|--------|--|
| PARAMETER | | SYMBOL | TYPICAL | MAXIMUM | UNIT | |
| Maximum junction-to-ambient b, d | t ≤ 5 s | R_{thJA} | 80 | 100 | °C /// | |
| Maximum junction-to-foot (drain) | Steady state | R _{thJF} | 55 | 70 | °C/W | |

Notes

- a. $T_C = 25$ °C
- b. Surface mounted on 1" x 1" FR4 board
- c. t = 5 s
- d. Maximum under steady state conditions is 130 °C/W



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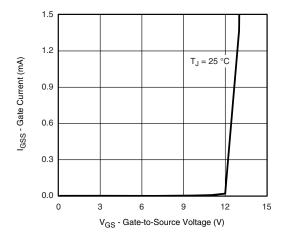
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNIT | |
|---|--------------------------------------|---|------|-------|----------|---------|--|
| Static | | | | | | • | |
| Drain-source breakdown voltage | V_{DS} | $V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$ | -20 | - | - | V | |
| V _{DS} temperature coefficient | $\Delta V_{DS}/T_{J}$ | J 050 A | - | -13 | - | | |
| V _{GS(th)} temperature coefficient | ΔV _{GS(th)} /T _J | I _D = -250 μA | - | 2.5 | - | mV/°C | |
| Gate-source threshold voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_D = -250 \mu A$ | -0.4 | - | -1 | V | |
| Cata acuraa laakaga | I _{GSS} | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$ | - | - | ± 6 | μΑ | |
| Gate-source leakage | | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 4.5 \text{ V}$ | - | - | ± 0.5 | | |
| Zoro gato voltago drain current | l | $V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}$ | - | - | -1 | | |
| Zero gate voltage drain current | I _{DSS} | V_{DS} = -20 V, V_{GS} = 0 V, T_J = 55 °C | - | - | -10 | | |
| On-state drain current ^a | I _{D(on)} | $V_{DS} \le -5 \text{ V}, V_{GS} = -4.5 \text{ V}$ | -15 | - | - | Α | |
| | | $V_{GS} = -4.5 \text{ V}, I_D = -3.2 \text{ A}$ | - | 0.050 | 0.061 | Ω | |
| Drain aguras en eteta registance a | | $V_{GS} = -2.5 \text{ V}, I_D = -2.8 \text{ A}$ | - | 0.065 | 0.080 | | |
| Drain-source on-state resistance a | R _{DS(on)} | V _{GS} = -1.8 V, I _D = -1.5 A | - | 0.090 | 0.110 | | |
| | | V _{GS} = -1.5 V, I _D = -0.5 A | - | 0.110 | 0.165 | | |
| Forward transconductance a | 9 _{fs} | $V_{DS} = -10 \text{ V}, I_D = -3.2 \text{ A}$ | - | 12 | - | S | |
| Dynamic ^b | | | | | | | |
| Total gate charge | Qg | $V_{DS} = -10 \text{ V}, V_{GS} = -8 \text{ V}, I_D = -5.3 \text{ A}$ | - | 14 | 21 | | |
| | | | - | 7.6 | 12 | nC | |
| Gate-source charge | Q_{gs} | V_{DS} = -10 V, V_{GS} = -4.5 V, I_D = -5.3 A | 1 | 0.8 | - | nC | |
| Gate-drain charge | Q_{gd} | | 1 | 3.1 | - | | |
| Gate resistance | R_g | f = 1 MHz | 0.4 | 2 | 4 | kΩ | |
| Turn-on delay time | t _{d(on)} | | 1 | 0.2 | 0.3 | | |
| Rise time | t _r | V_{DD} = -10 V, R_L = 2.3 Ω | - | 1 | 1.5 | | |
| Turn-off delay time | t _{d(off)} | $I_D\cong$ -4.3 A, $V_{GEN}=$ -4.5 V, $R_g=$ 1 Ω | - | 4 | 6 | | |
| Fall time | t _f | | 1 | 2 | 3 | | |
| Turn-on delay time | t _{d(on)} | | 1 | 0.09 | 0.14 | μs - | |
| Rise time | t _r | V_{DD} = -10 V, R_L = 2.3 Ω | - | 0.4 | 0.6 | | |
| Turn-off delay time | t _{d(off)} | $I_D\cong$ -4.3 A, V_{GEN} = -8 V, R_g = 1 Ω | - | 5.2 | 7.8 | | |
| Fall time | t _f | | - | 2.3 | 3.5 | | |
| Drain-Source Body Diode Characterist | ics | | | | | | |
| Continuous source-drain diode current | IS | T _C = 25 °C | - | - | -1.5 | ^ | |
| Pulse diode forward current | I _{SM} | | - | - | -20 | A | |
| Body diode voltage | V_{SD} | $I_{S} = -3 \text{ A}, V_{GS} = 0 \text{ V}$ | - | -0.8 | -1.2 | V | |
| Body diode reverse recovery time | t _{rr} | | - | 30 | 60 | ns | |
| Body diode reverse recovery charge | Q _{rr} | $I_F = -3 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$ | - | 20 | 40 | nC | |
| Reverse recovery fall time | t _a | $T_J = 25 ^{\circ}C$ | - | 13 | - | | |
| Reverse recovery rise time | t _b | | _ | 17 | | ns | |

Notes

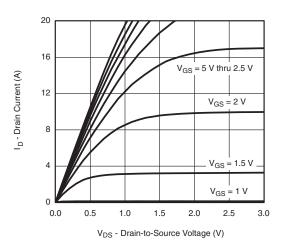
- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2%
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

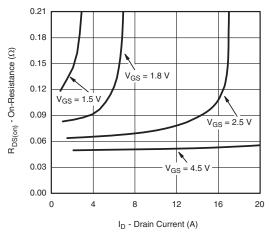




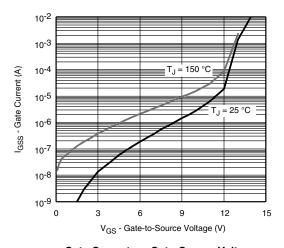
Gate Current vs. Gate-Source Voltage



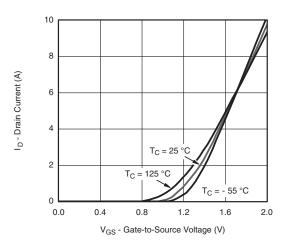
Output Characteristics



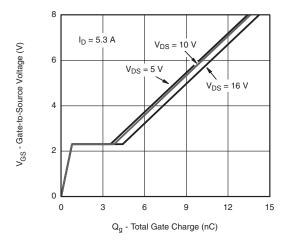
On-Resistance vs. Drain Current



Gate Current vs. Gate-Source Voltage

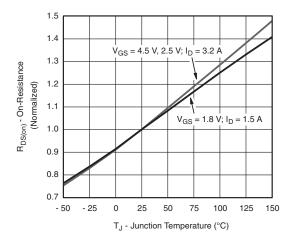


Transfer Characteristics

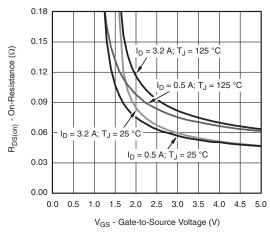


Gate Charge

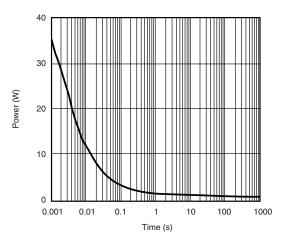




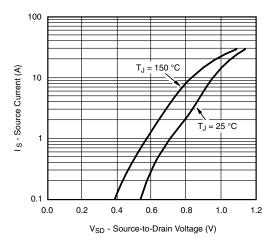
On-Resistance vs. Junction Temperature



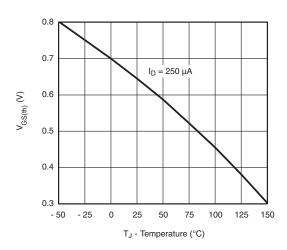
On-Resistance vs. Gate-to-Source Voltage



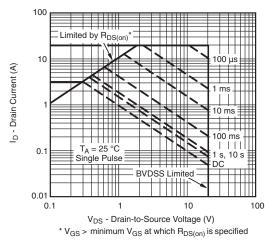
Single Pulse Power, Junction-to-Ambient



Source-Drain Diode Forward Voltage

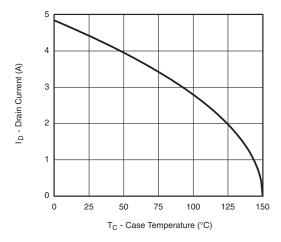


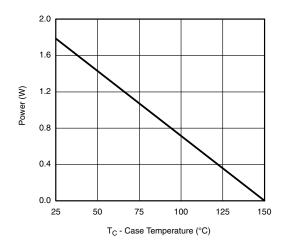
Threshold Voltage



Safe Operating Area, Junction-to-Ambient





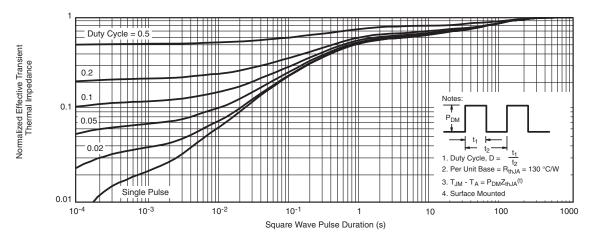


Current Derating ^a

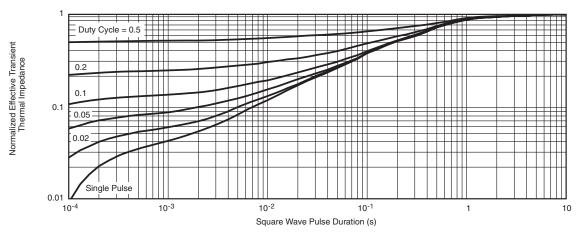
Power Derating

a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for silicon technology and package reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg265905.

Vishay Siliconix

SOT-23 (TO-236): 3-LEAD







| Dim | MILLI | METERS | INCHES | | |
|------------------------|----------|--------|------------|-------|--|
| | Min | Max | Min | Max | |
| Α | 0.89 | 1.12 | 0.035 | 0.044 | |
| A ₁ | 0.01 | 0.10 | 0.0004 | 0.004 | |
| A ₂ | 0.88 | 1.02 | 0.0346 | 0.040 | |
| b | 0.35 | 0.50 | 0.014 | 0.020 | |
| С | 0.085 | 0.18 | 0.003 | 0.007 | |
| D | 2.80 | 3.04 | 0.110 | 0.120 | |
| E | 2.10 | 2.64 | 0.083 | 0.104 | |
| E ₁ | 1.20 | 1.40 | 0.047 | 0.055 | |
| е | 0.95 BSC | | 0.0374 Ref | | |
| e ₁ | 1.90 BSC | | 0.0748 Ref | | |
| L | 0.40 | 0.60 | 0.016 | 0.024 | |
| L ₁ | 0.64 Ref | | 0.025 Ref | | |
| S | 0.50 Ref | | 0.020 Ref | | |
| q | 3° | 8° | 3° | 8° | |
| FCN: S-03946-Rev K 09- | lul-01 | • | | | |

ECN: S-03946-Rev. K, 09-Jul-01

DWG: 5479

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RECOMMENDED MINIMUM PADS FOR SOT-23



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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